

# AN14474

## i.MX 9 - L3 Cache Partitioning for Predictable Real-Time Performance

Rev. 1.2 — 19 February 2025

Application note

### Document information

Information	Content
Keywords	AN14474, L3 Cache, L3 Cache Partitioning, Real-Time, i.MX 93, i.MX 95, ARM DynamIQ Shared Unit, DSU
Abstract	This application note describes how to partition the L3 cache between the cores, using features of the Arm DynamIQ Shared Unit.



## 1 Introduction

In most CPU clusters, L3 cache is a shared resource, which typically gives the best overall performance of the system for a given cache size. However, this may not be ideal in real-time situations. For example, if a low-priority task is memory-intensive, it may pollute the entire L3 cache of the cluster, increasing the latency of a higher-priority task. This is undesirable in a real-time environment.

This document describes how to partition the L3 cache between the cores, using features of the Arm DynamIQ Shared Unit. Furthermore, it shows how to allocate specific tasks (high priority real-time) on cores with dedicated partitions of L3 cache. The code in this document was tested on i.MX 95 and i.MX 93.

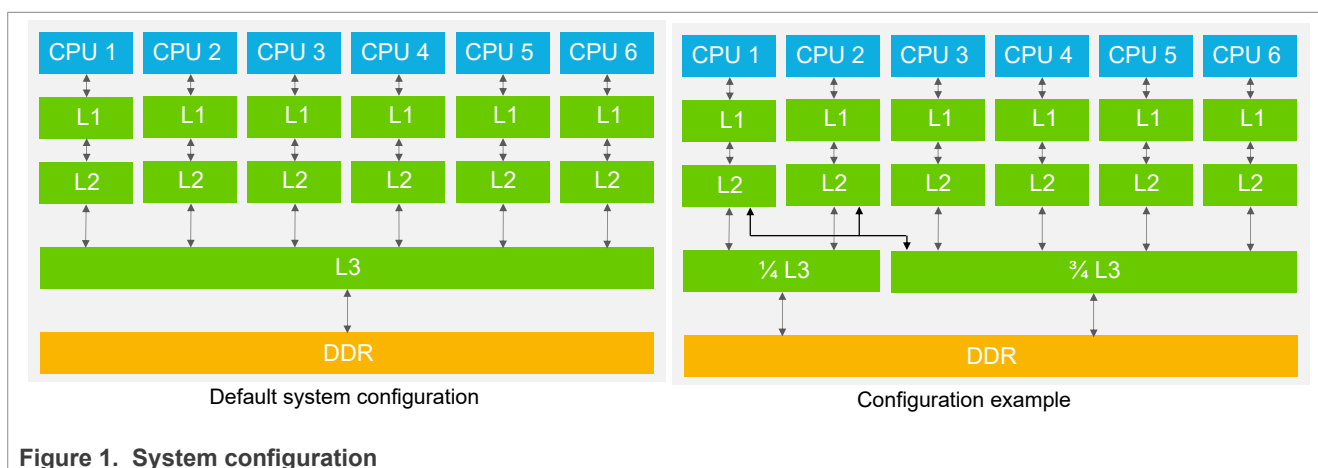


Figure 1. System configuration

As shown in [Figure 1](#),

- the left image shows the default L3 cache configuration on i.MX 95, shared among all the cores.
- the right image shows a possible configuration in which  $\frac{1}{4}$  of L3 cache is used exclusively by CPU 1 and CPU 2, while the remaining  $\frac{3}{4}$  of L3 cache is shared among all six cores.

## 2 General approach

For a complete description of how to partition L3 cache, see [Arm® DynamIQ™ Shared Unit Technical Reference Manual](#). In a nutshell, the L3 cache is divided in four equal way groups (a fancy name for parts), numbered 0-3. Each way group can be assigned to one or more of the eight "schemes", numbered 0-7. A scheme is simply a set of way groups. All unassigned way groups are shared among all eight schemes. Each CPU has to be allocated to one of the schemes and have access to the cache of that scheme. To implement the example in [Figure 1](#), perform the following steps:

1. Assign way group 0 of the cache to scheme ID 1.
2. Leave way groups 1-3 of the cache unassigned (or, alternatively, assign way groups 1-3 to both schemes ID 0 and ID 1).
3. Set CPU 1-2 to use scheme ID 1.
4. Set CPU 3-6 to use scheme ID 0.

It is obligatory that all **used** schemes have exclusive access, or shared access to at least one-way group of the cache.

To implement the cache partitioning, this solution provides access from the Linux user-space to the following registers: `CLUSTERPARTCR_EL1` and `CLUSTERTHREADSID_EL1`. This provides flexibility and ease of configuration, but some protections may be required in a production system. For the complete description of the registers, see the manual referenced above. Briefly:

- `CLUSTERPARTCR_EL1` configures the allocation of the cache way groups to the schemes.
- `CLUSTERTHREADSID_EL1`, one per core, allows setting the scheme ID used by that core.

In this implementation, `CLUSTERACPSID_EL1` and `CLUSTERSTASHSID_EL1` are left on their default value (0), which means that ACP transactions and stash requests are directed to scheme ID 0. Make sure that scheme ID 0 has access to at least one way group.

This solution adds a kernel module, which exposes one read/write `sysfs` file for each of the relevant registers. Writes and reads to these files are forwarded to a patched TF-A, which is able to read/write these registers (running at Exception Level 3).

For testing, we reserve a part of the cache for the exclusive use of some of the cores. We evaluate the performance of a real-time task running on the cores with exclusive cache while the rest of the processes, run on the other cores. We use memory-intensive tasks which are strongly affected by the cache performance.

### 3 Implementation

The current implementation is based on the LF-6.6.23\_2.0.0 BSP release. Other versions may require porting.

1. On the Linux PC, set up the Yocto environment according to Section 3, 4, and 5, in the *i.MX Yocto Project User's Guide* (document [UG10164](#)). For i.MX93 only you can, alternatively, use the [Real-Time Edge Software](#), according to Section 3, 4 and 5 in the *Real-time Edge Yocto Project User Guide* (document [RTEDGEYOCTOUG](#)).
2. Clone the [recipes-cachepartition](#) repository in the `meta-imx/meta-imx-bsp` directory. The `recipes-cachepartition` directory contains the following recipe appends:
  - A kernel patch implementing the kernel module for the L3 cache partitioning (in `linux-imx` subdirectory).
  - An ATF patch implementing the necessary SMC calls for setting the registers (in `imx-atf`).
  - A small tool, `usecache`, which can be used to test the amount of available cache (in `usecache`).

```
$ cd ~/imx-yocto-bsp/sources/meta-imx/meta-imx-bsp
$ git clone -b lf-6.6.23-2.0.0 https://github.com/nxp-imx-support/recipes-cachepartition
```

3. To use the Preempt-RT kernel in the standard Linux distribution, see the [How to Use the Preempt-RT Kernel in the Standard Yocto Linux BSP](#).
4. `rt-tests` contains the `cyclictest` tool, useful to measure the system latency. You can build it by adding the following lines to the `conf/local.conf` file.

```
CORE_IMAGE_EXTRA_INSTALL += " rt-tests"
```

**Note:**

[i.MX 93] If you are using Real-Time Edge, the Preempt-RT kernel is default, and these lines are not needed.

5. Add the `usecache` package to the image. `usecache` is a cache stress test, which can be used for the L3 cache partitioning validation. Add the below line in the `conf/local.conf` file.

```
CORE_IMAGE_EXTRA_INSTALL += " usecache"
```

6. Build the `imx-image-full` image.

```
bitbake imx-image-full
```

**Note:**

[i.MX 93] If you are using Real-Time Edge, run, instead, the following command:

```
bitbake nxp-image-real-time-edge
```

7. Write the resulted `<image_name>.wic.zst` image located in the `tmp/deploy/images/<machine>` directory on the SD card using the following command:

```
$ zstd -d <image_name>.wic.zst
$ sudo dd if=<image_name>.wic of=/dev/sd<x> bs=1M conv=fsync
```

## 4 Testing

To test, perform the following steps:

1. Connect the USB debug port of the board to the PC using a USB cable. This action creates four virtual serial ports on the PC. Typically, the third serial port corresponds to the Linux console. Open this port in a terminal emulator using the following parameters: 115200 baud rate, 8 data bits, no parity, and 1 stop bit.
2. Boot the board.
3. Load the `cachepartition` module. The module prints various debug messages in the kernel log, which can be inspected with `dmesg`.

```
modprobe cachepartition
```

4. Go to the `/sys/kernel/cachepartition` directory. Here locate the following files: `PARTCR_EL1`, and `THREADSID_EL1_[0-5]` - one for each core.
5. You can check the current value of the registers using `cat`. Example:

```
cat partcr_el1
```

6. You can set the value of the registers using `echo`. Example:

```
echo e1 > partcr_el1
```

### 4.1 Examples of configuration

To configure, perform the following steps:

1. Default configuration: All the L3 caches are shared among all cores.

```
echo 0 > partcr_el1
```

2.  $\frac{3}{4}$  L3 cache to cores 4-5 (Scheme ID 1), and  $\frac{1}{4}$  L3 cache to cores 0-3, ACP and STASH (Scheme ID 0). The value written in the `partcr_el1` register is E1, which is 11100001 in binary. It means that way groups 3, 2, 1 are assigned to Scheme ID 1 (first 4 bits) and the way group 0 – assigned to Scheme ID 0. Then, we select Scheme ID 0 for cores 0-3 and Scheme ID 1 for cores 4-5.

```
echo e1 > partcr_el1
echo 0 > threadSid_el1_0
echo 0 > threadSid_el1_1
echo 0 > threadSid_el1_2
echo 0 > threadSid_el1_3
echo 1 > threadSid_el1_4
echo 1 > threadSid_el1_5
```

You can check that the configuration is working using the `usecache` tool.

- ```
taskset -c 0 usecache 512 100 0
taskset -c 4 usecache 512 100 4
```

## i.MX 9 - L3 Cache Partitioning for Predictable Real-Time Performance

The previous commands run the same `usecache` test on CPU 0 and on CPU 4. `usecache` is a memory intensive task, and it uses, in this case, 512 K of memory. Given that CPU 4 has access to more L3 cache than CPU 0, it runs significantly faster.

- ```
taskset -c 0 usecache 64 100 0
taskset -c 4 usecache 64 100 4
```

In this case, the memory space used by the `usecache` is 64 K, and fits in the L1-L3 cache of all CPUs, so it runs in approximately equal time.

- ```
taskset -c 0 usecache 512 100 0 & taskset -c 4 usecache 512 100 4
```

In this case, we run `usecache` simultaneously on CPU 0 and CPU 4, but because they have access to separate parts of the cache, the time remains about the same as when we run separately.

- ```
taskset -c 0 usecache 512 100 0 & taskset -c 1 usecache 512 100 1
```

In this case, we run `usecache` simultaneously on CPU 0 and CPU 1, but because they share the same L3 cache partition, the time increases, compared to when run separately.

3. Cores 4-5 have access to all the L3 cache (Scheme ID 2), cores 0-3 have access only to the first ¼ of L3 cache (Scheme ID 1), ACP and STASH have access only to the second ¼ of L3 cache (Scheme ID 0). The value F84 written in the `partcr_el1` register is 111110000100, which means that Scheme ID 2 has access to all 4-way groups (the four most significant bits), Scheme ID 1 has access only to way group 3 (the middle four bits) and Scheme ID 0 has access only to way group 2 (the four least significant bits).

```
echo f84 > partcr_el1
echo 1 > threadid_el1_0
echo 1 > threadid_el1_1
echo 1 > threadid_el1_2
echo 1 > threadid_el1_3
echo 2 > threadid_el1_4
echo 2 > threadid_el1_5
```

Again, you can use `usecache` to test the performance in this case.

To compile the `rt-tests` package and the Preempt-RT Linux kernel, use the `cyclictest` to test the system latency on the various cores.

When using the Jailhouse hypervisor, configure the L3 cache before enabling Jailhouse. Once Jailhouse is enabled, it restricts the communication between the kernel and the ATF. You can always disable Jailhouse temporarily, to change the L3 cache configuration.

## 5 Note about the source code in the document

Example code shown in this document has the following copyright and BSD-3-Clause license:

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## 6 Revision history

[Table 1](#) summarizes the revisions to this document.

Table 1. Revision history

Document ID	Release date	Description
AN14474 v.1.2	19 February 2025	Use the GitHub repository for the <code>recipes-cachepartition</code> , instead of a SW archive
AN14474 v.1.1	28 October 2024	Added hyperlink of AN14474SW in <a href="#">Section 3</a>
AN14474 v.1.0	24 October 2024	Initial public release

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Contents

1 Introduction ..... 2

2 General approach ..... 2

3 Implementation ..... 3

4 Testing ..... 4

4.1 Examples of configuration ..... 4

5 Note about the source code in the document ..... 5

6 Revision history ..... 6

Legal information ..... 7

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